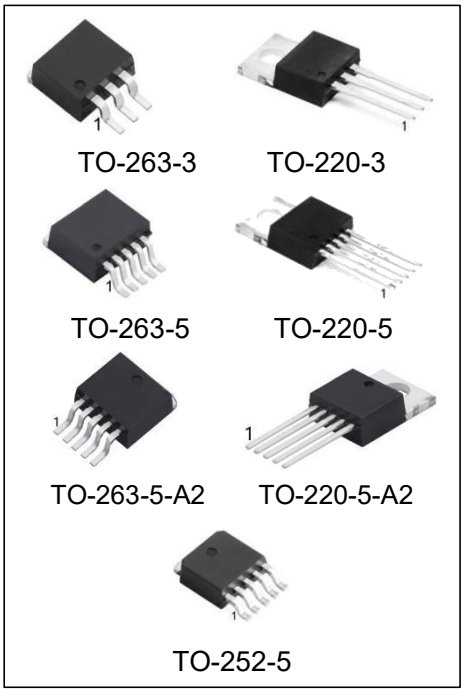
MIC29152/29302/29502/29752 High-Current Low-Dropout Regulators

Features

- High current capability
  MIC29150/29151/29152/29153——1.5A
  MIC29300/29301/29302/29303——3A
  MIC29500/29501/29502/29503——5A
  MIC29750/29751/29752——7.5A
- Low-dropout voltage
- Low ground current
- Accurate 1% guaranteed tolerance
- Extremely fast transient response
- Reverse-battery and “Load Dump” protection
- Zero-current shutdown mode (5-pin versions)
- Error flag signals output out-of-regulation (5-pin versions)
- Also characterized for smaller loads with industry- leading performance specifications
- Fixed voltage and adjustable versions



Applications

- Battery powered equipment
- High-efficiency “Green” computer systems
- Automotive electronics
- High-efficiency linear lower supplies
- High-efficiency lost-regulator for switching supply

General Description

The MIC29150/29300/29500/29750 are high current, high accuracy, low-dropout voltage regulators. Using proprietary Super βeta PNP® process with a PNP pass element, these regulators feature 350mV to 425mV (full load) typical dropout voltages and very low ground current. Designed for high current loads, these devices also find applications in lower current, extremely low dropout-critical systems, where their tiny dropout voltage and ground current values are important attributes.

The MIC29150/29300/29500/29750 are fully protected against overcurrent faults, reversed input polarity, reversed lead insertion, overtemperature operation, and positive and negative transient voltage spikes. Five pin fixed voltage versions feature logic level ON/OFF control and an error flag which signals whenever the output falls out of regulation. Flagged states include low input voltage (dropout), output current limit, overtemperature shutdown, and extremely high voltage spikes on the input.

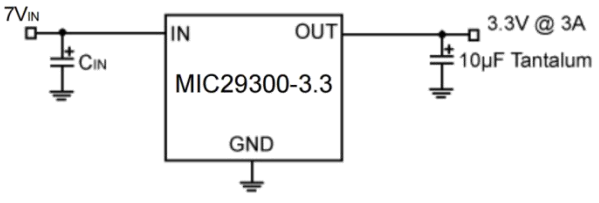
On the 29xx1 and 29xx2, the ENABLE pin may be tied to VIN if it is not required for ON/OFF control. The MIC29150/29300/29500 are available in 3-pin and 5-pin TO-220 and surface mount TO-263 (D2Pak) packages. The 29750 7.5A regulators are available in 3-pin and5-pin . The 1.5A, adjustable output 29152 is available in a 5-pin power D-Pak (TO-252) package.

Ordering Information

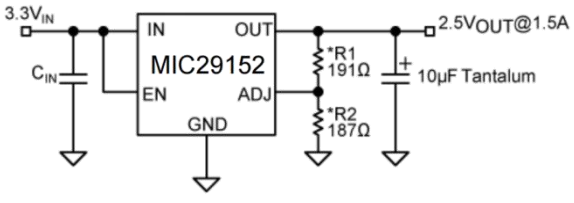
DEVICE	Package Type	MARKING	Packing	Packing Qty
MIC29150T-XX/HG	TO-220-3	MIC29150-XX	TUBE	1000pcs/box
MIC29300T-XX/HG	TO-220-3	MIC29300-XX	TUBE	1000pcs/box
MIC29500T-XX/HG	TO-220-3	MIC29500-XX	TUBE	1000pcs/box
MIC29150S-XX/TR-HG	TO-263-3	MIC29150-XX	REEL	500pcs/reel
MIC29300S-XX/TR-HG	TO-263-3	MIC29300-XX	REEL	500pcs/reel
MIC29152DT/TR-HG	TO-252-5	29152	REEL	2000pcs/reel
MIC29151T-XX/HG	TO-220-5/TO-220-5-A2	MIC29151-XX	TUBE	1000pcs/box
MIC29301T-XX/HG	TO-220-5/TO-220-5-A2	MIC29301-XX	TUBE	1000pcs/box
MIC29501T-XX/HG	TO-220-5/TO-220-5-A2	MIC29501-XX	TUBE	1000pcs/box
MIC29751T-XX/HG	TO-220-5/TO-220-5-A2	MIC29751-XX	TUBE	1000pcs/box
MIC29151S-XX/TR-HG	TO-263-5/TO-263-5-A2	MIC29151-XX	REEL	500pcs/reel
MIC29301S-XX/TR-HG	TO-263-5/TO-263-5-A2	MIC29301-XX	REEL	500pcs/reel
MIC29501S-XX/TR-HG	TO-263-5/TO-263-5-A2	MIC29501-XX	REEL	500pcs/reel
MIC29751S-XX/TR-HG	TO-263-5/TO-263-5-A2	MIC29751-XX	REEL	500pcs/reel
MIC29152T/HG	TO-220-5/TO-220-5-A2	MIC29152	TUBE	1000pcs/box
MIC29302AT/HG	TO-220-5/TO-220-5-A2	MIC29302A	TUBE	1000pcs/box
MIC29502WT/HG	TO-220-5/TO-220-5-A2	MIC29502	TUBE	1000pcs/box
MIC29152S/TR-HG	TO-263-5/TO-263-5-A2	MIC29152	REEL	500pcs/reel
MIC29302AS/TR-HG	TO-263-5/TO-263-5-A2	MIC29302A	REEL	500pcs/reel
MIC29502WS/TR-HG	TO-263-5/TO-263-5-A2	MIC29502	REEL	500pcs/reel
MIC29153T/HG	TO-220-5/TO-220-5-A2	MIC29153	TUBE	1000pcs/box
MIC29303T/HG	TO-220-5/TO-220-5-A2	MIC29303	TUBE	1000pcs/box
MIC29503T/HG	TO-220-5/TO-220-5-A2	MIC29503	TUBE	1000pcs/box
MIC29153S/TR-HG	TO-263-5/TO-263-5-A2	MIC29153	REEL	500pcs/reel
MIC29303S/TR-HG	TO-263-5/TO-263-5-A2	MIC29303	REEL	500pcs/reel
MIC29503S/TR-HG	TO-263-5/TO-263-5-A2	MIC29503	REEL	500pcs/reel

Notes: “ xx ” may be 1.5, 1.8, 2.5, 3.3, 5.0.

Typical Application**



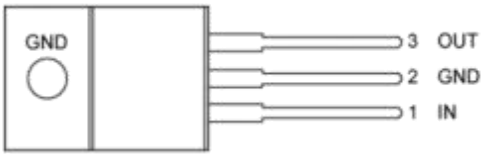
Fixed Output Voltage



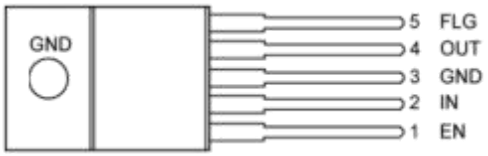
Adjustable Output Voltag

(*See Minimum Load Current Section)

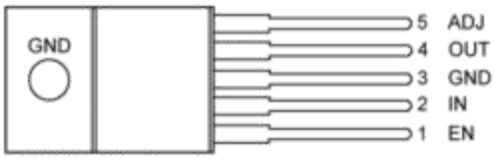
Pin Configuration



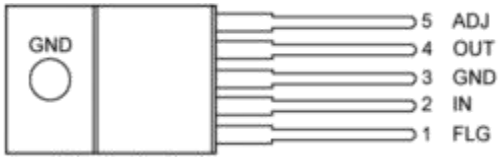
3-Pin TO-220
MIC29150/29300/29500



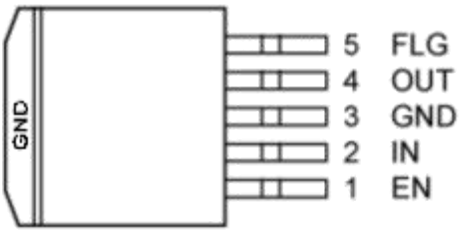
5-Pin TO-220 Fixed Voltage
MIC29151/29301/29501/29751



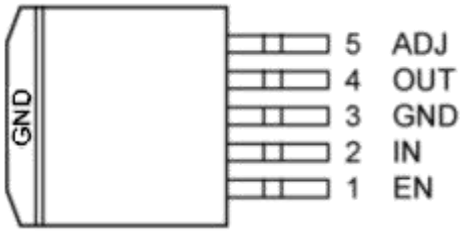
5-Pin TO-220 Adjustable Voltage
MIC29152/29302A/29502



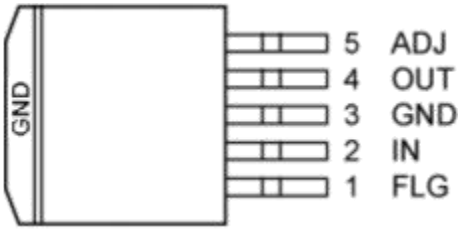
5-Pin TO-220 Adjustable with Flag
MIC29153/29303/29503



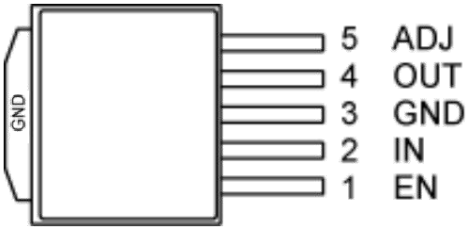
5-Pin TO-263 Fixed Voltage
MIC29151/29301/29501



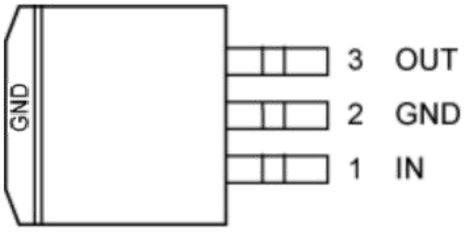
5-Pin TO-263 Adjustable Voltage
MIC29302A/29502



5-Pin TO-263 Adjustable with Flag
MIC29153/29303/29503



5-Pin TO-252 Adjustable Voltage
MIC29152



3-Pin TO-263
MIC29150/29300

Pin Description

Pin Number TO-220 TO-263	Pin Name
1	INPUT: Supplies the current to the output power device
2	GND: TAB is also connected internally to the IC's ground on D-PAK.
3	OUTPUT: The regulator output voltage

Pin Description

Pin Number Fixed TO-220 TO-263	Pin Number Adjustable TO-220 TO-252 TO-263	Pin Number Adj. with Flag TO-220 TO-263	Pin Name
1	1	—	ENABLE: CMOS compatible control input. Logic high = enable, logic low = shutdown.
2	2	2	INPUT: Supplies the current to the output power device
3, TAB	3, TAB	3, TAB	GND: TAB is also connected internally to the IC's ground on D-PAK.
4	4	4	OUTPUT: The regulator output voltage
—	5	5	ADJUST: Adjustable regulator feedback input that connects to the resistorvoltage divider that is placed from OUTPUT to GND in order to set the output voltage.
5	—	1	FLAG: Active low error flag output signal that indicates an output fault condition

Absolute Maximum Ratings(1)

Parameter		Value
Input Supply Voltage (V_{IN})(1)		+26V
Enable Input Voltage (V_{EN})		-0.3V to V_{IN}
Lead Temperature (soldering, 10sec.)	TO-263/TO-220	245°C
	TO-252	260°C
Power Dissipation		Internally Limited
Storage Temperature Range		-65°C to +150°C
ESD Rating		Note 3

Operating Ratings(2)

Parameter	Value
Operating Junction Temperature	-40°C to +125°C
Maximum Operating Input Voltage	26 V
Package Thermal Resistance	
TO-220 (θ_{JC})	2°C/W
TO-263 (θ_{JC})	3°C/W
TO-252 (θ_{JC})	3°C/W
TO-263 (θ_{JA})	28°C/W
TO-252 (θ_{JA})	56°C/W

Electrical Characteristics

V_{IN} = V_{OUT} + 1V; I_{OUT} = 10mA; T_J = 25°C, bold values indicate –40°C≤ T_J ≤ +125°C, unless noted.

Parameter	Condition	Min	Typ	Max	Units
Output Voltage	I_{OUT} = 10mA	–1		1	%
	10mA ≤ I_{OUT} ≤ I_{FL}, (V_{OUT} + 1V) ≤ V_{IN} ≤26V (5)	–2		2	%
Line Regulation	I_{OUT} = 10mA, (V_{OUT} + 1V) ≤ V_{IN} ≤26V		0.06	0.5	%
Load Regulation	V_{IN} = V_{OUT} + 5V, 10mA ≤ I_{OUT} ≤ 1.5A (5,9)		0.2	1	%
$\frac{\Delta V_O}{\Delta T}$	Output Voltage (9) Temperature Coefficient.		20	100	ppm/°C
Dropout Voltage	ΔVOUT = -1%				
	MIC29150 I_{OUT} = 100mA		80	200	mV
	I_{OUT} = 750mA		220		
	I_{OUT} = 1.5A		350	600	
	MIC29300 I_{OUT} = 100mA		80	175	
	I_{OUT} = 1.5A		250		
	I_{OUT} = 3A		370	600	
	MIC29500 I_{OUT} = 250mA		125	250	
	I_{OUT} = 2.5A		250		
	I_{OUT} = 5A		370	600	
	MIC29750 I_{OUT} = 250mA		80	200	
	I_{OUT} = 4A		270		
	I_{OUT} = 7.5A		425	750	
Ground Current	MIC29150 I_{OUT} = 750mA, V_{IN} = V_{OUT} + 1V		8	20	mA
	I_{OUT} = 1.5A		22		
	MIC29300 I_{OUT} = 1.5A, V_{IN} = V_{OUT} + 1V		10	35	mA
	I_{OUT} = 3A		37		
	MIC29500 I_{OUT} = 2.5A, V_{IN} = V_{OUT} + 1V		15	50	mA
	I_{OUT} = 5A		70		
	MIC29750 I_{OUT} = 4A, V_{IN} = V_{OUT} + 1V		35	75	mA
	Note 8 I_{OUT} = 7.5A		120		
I_{GRNDDO}Ground Pin Current at Droupout	V_{IN} = 0.5V less than specified V_{OUT} × I_{OUT} = 10mA				
	MIC29150		0.9		mA
	MIC29300		1.7		mA
	MIC29500		2.1		mA
	MIC29750		3.1		mA
Current Limit	MIC29150 VOUT = 0V		2.1	3.5	A
	MIC29300 VOUT = 0V		4.5	5.0	A
	MIC29500 VOUT = 0V		7.5	10.0	A
	MIC29750 VOUT = 0V		9.5	15	A
Parameter	Condition	Min	Typ	Max	Units
e_n,Output Noise Voltage (10Hz to 100kHz) I_L = 100mA	C_L = 10μF		400		μV (rms)
	C_L = 33μF		260		
Ground Current in Shutdown	29150/1/2/3 only V_{EN} = 0.4V		2	10 30	μAμA
Reference	MIC29xx2/29xx3				
Reference Voltage		1.228 1.215	1.240	1.252 1.265	V V
Reference Voltage		1.203		1.277	V

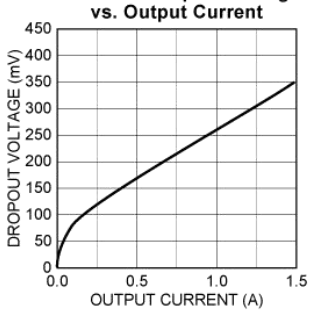
Adjust Pin Bias Current			40	80 120	nA
Reference Voltage Temperature Coefficient	(10)		20		ppm/°C
Adjust Pin BiasCurrent Temperature Coefficient			0.1		nA/°C
Flag Output (Error Comparator) MIC29xx1/29xx3					
Output LeakageCurrent	V_{OH} = 26V		0.01	1.00 2.00	µA
Output Low Voltage	Device set for 5V, V_{IN} = 4.5V I_{OL} = 250µA		220	300 400	mV
Upper Threshold Voltage	Device set for 5V (11)	40 25	60		mV
Lower Threshold Voltage	Device set for 5V (11)		75	95 140	mV
Hysteresis	Device set for 5V (11)		15		mV
ENABLE Input	MIC29xx1/29xx2				
Input Logic Voltage Low(OFF) High (ON)		2.4		0.8	V
Enable Pin Input Current	V_{EN} = 26V		100	600 750	µA
	V_{EN} = 0.8V	0.7		2 4	µA
Regulator Output Current in Shutdown	(12)		10	500	µA

Notes:

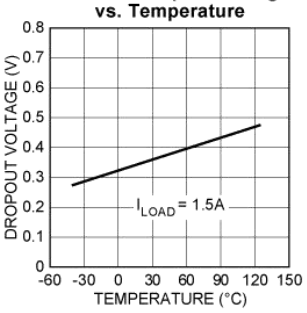
1. Maximum positive supply voltage of 26V must be of limited duration (<100msec) and duty cycle (≤1%). The maximum continuous supply voltage is 26V. Exceeding the absolute maximum rating may damage the device.
2. The device is not guaranteed to function outside its operating rating.Operating Junction temperature range: -40°C to +125°C. This product is designed for industrial grade applications. For automotive grade versions compliant with AEC-Q100, please conduct internal screening per the standard or contact our sales team for availability.
3. Devices are ESD sensitive. Handling precautions recommended.
4. Specification for packaged product only.
5. Full load current (IFL) is defined as 1.5A for the MIC29150, 3A for the MIC29300, 5A for the MIC29500, and 7.5A for the MIC29750 families.
6. Dropout voltage is defined as the input-to-output differential when the output voltage drops to 99% of its normal value with VOUT + 1V applied to VIN.
7. VIN = VOUT (nominal) + 1V. For example, use VIN = 4.3V for a 3.3V regulator or use 6V for a 5V regulator. Employ pulse-testing procedures to pin current.
8. Ground pin current is the regulator quiescent current. The total current drawn from the source is the sum of the load current plus the ground pin current.
9. Output voltage temperature coefficient is defined as the worst case voltage change divided by the total temperature range.
10. Thermal regulation is defined as the change in output voltage at a time T after a change in power dissipation is applied, excluding load or line regulation effects. Specifications are for a200mA load pulse at VIN = 20V (a 4W pulse) for T = 10ms.
11. Comparator thresholds are expressed in terms of a voltage differential at the Adjust terminal below the nominal reference voltage measured at 6V input. To express these thresholds in terms of output voltage change, multiply by the error amplifier gain = VOUT/VREF = (R1 + R2)/R2. For example, at a programmed output voltage of 5V, the Error output is guaranteed to go low when the output drops by 95mV x 5V/1.240V = 384mV. Thresholds remain constant as a percent of VOUT as VOUT is varied, with the dropout warning occurring at typically 5% below nominal, 7.7% guaranteed.
12. VEN ≤ 0.8V and VIN ≤ 26V, VOUT = 0.
13. When used in dual supply systems where the regulator load is returned to a negative supply, the output voltage must be diode clamped to ground.

Typical Characteristics MIC2915x

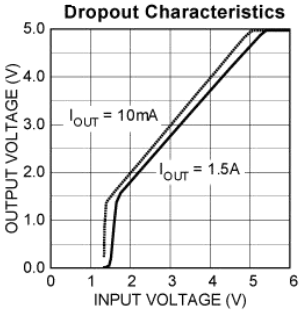
2915x Dropout Voltage vs. Output Current



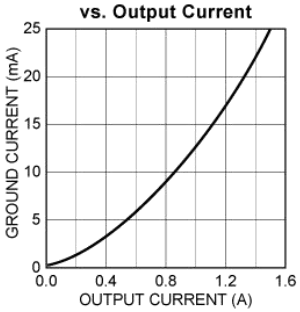
2915x Dropout Voltage vs. Temperature



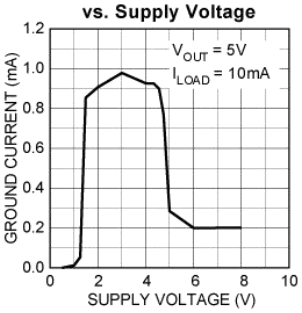
29150-5.0 Dropout Characteristics



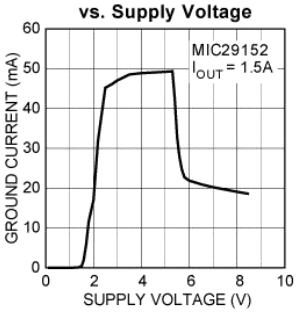
2915x Ground Current vs. Output Current



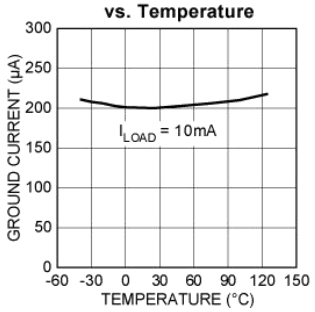
2915x Ground Current vs. Supply Voltage



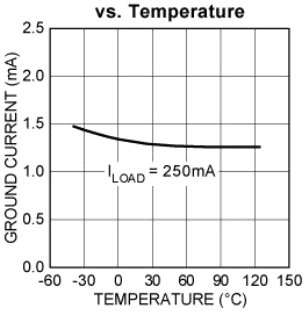
2915x Ground Current vs. Supply Voltage



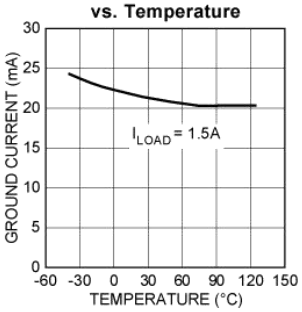
2915x Ground Current vs. Temperature



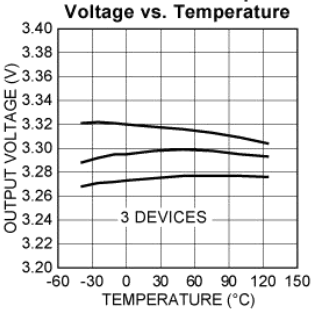
2915x Ground Current vs. Temperature



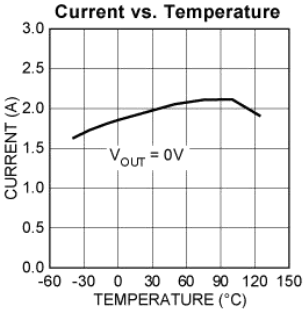
2915x Ground Current vs. Temperature



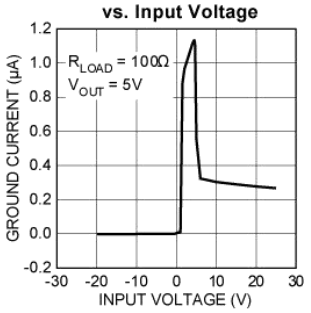
29150-3.3 Output Voltage vs. Temperature



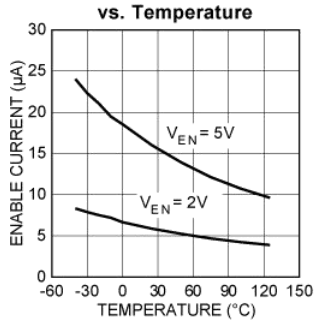
29150-3.3 Short Circuit Current vs. Temperature



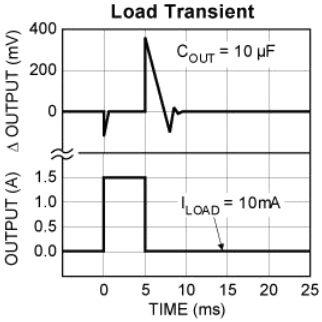
2915x Ground Current vs. Input Voltage



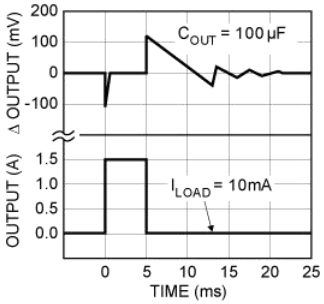
29151-xx/2 Enable Current vs. Temperature



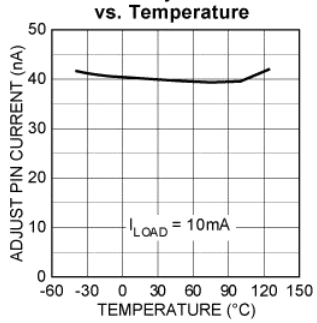
2915x Load Transient



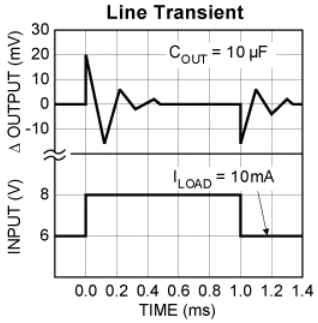
2915x Load Transient



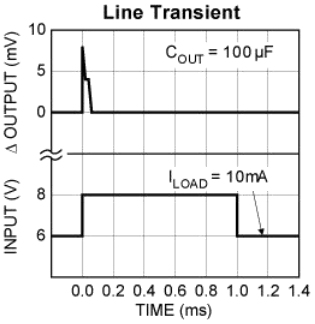
29152/3 Adjust Pin Current vs. Temperature



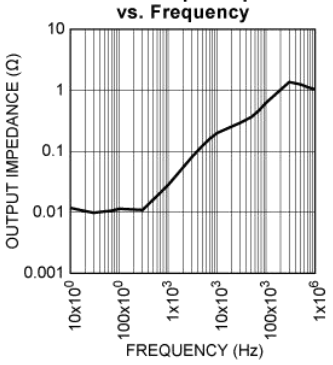
2915x Line Transient



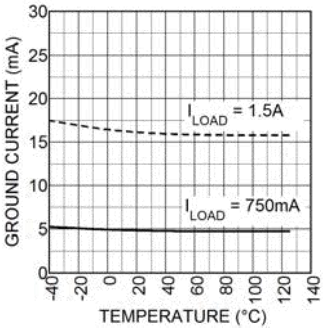
2915x Line Transient



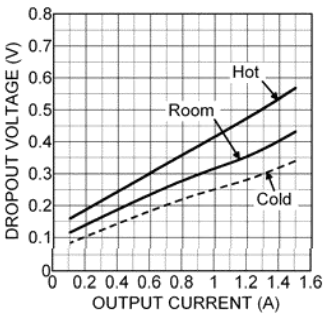
2915x Output Impedance vs. Frequency



29152 Ground Current vs. Temperature

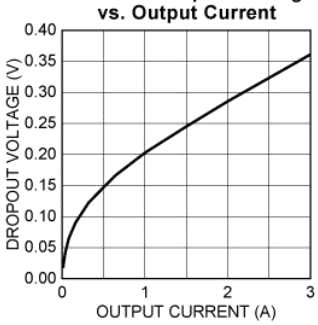


29152 Dropout Voltage vs. Output Current

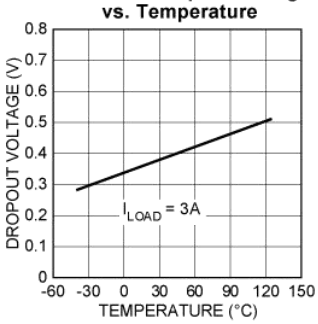


Typical Characteristics MIC2930X

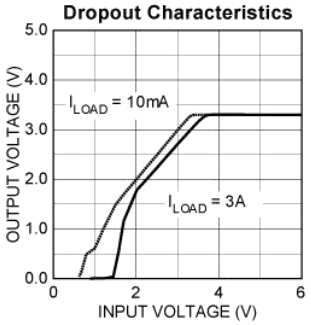
2930x Dropout Voltage vs. Output Current



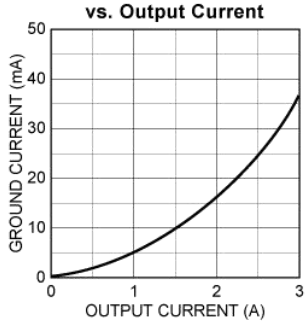
2930x Dropout Voltage vs. Temperature



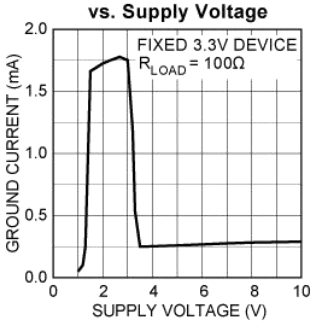
29300-3.3 Dropout Characteristics



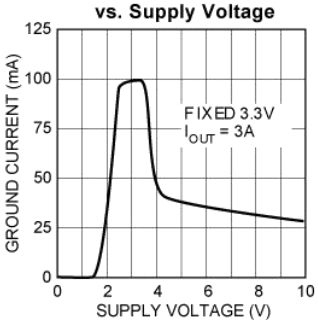
2930x Ground Current vs. Output Current



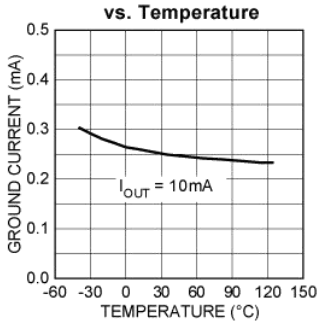
2930x Ground Current vs. Supply Voltage



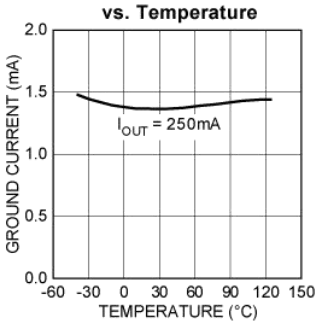
2930x Ground Current vs. Supply Voltage



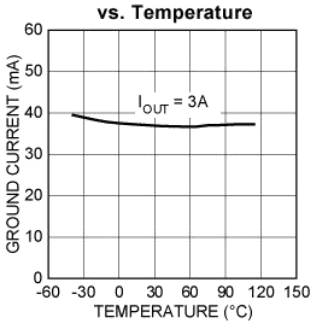
2930x Ground Current vs. Temperature



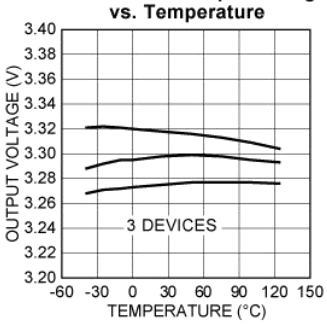
2930x Ground Current vs. Temperature



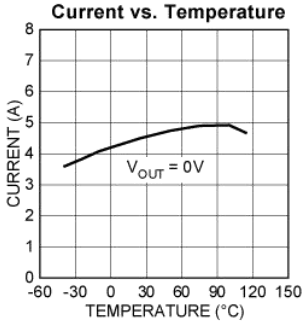
2930x Ground Current vs. Temperature



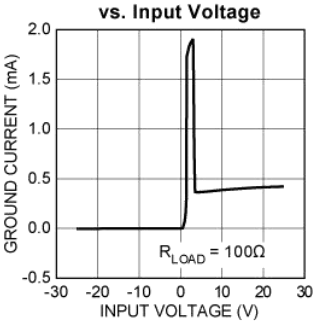
29300-3.3 Output Voltage vs. Temperature



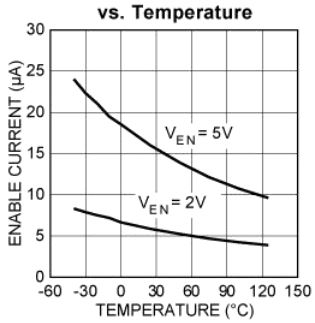
29300-5.0 Short Circuit Current vs. Temperature



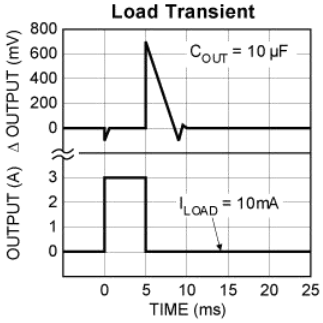
2930x Ground Current vs. Input Voltage



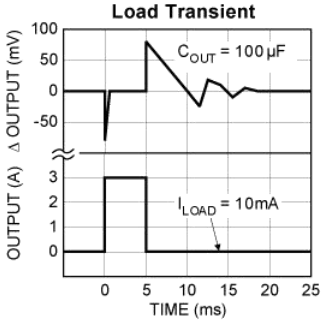
29301-xx/2 Enable Current vs. Temperature



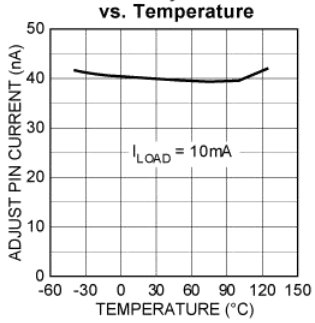
2930x Load Transient



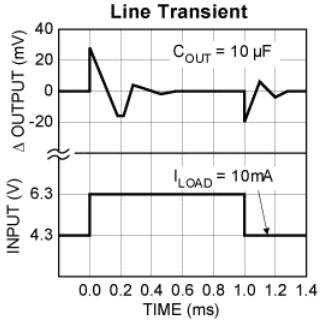
2930x Load Transient



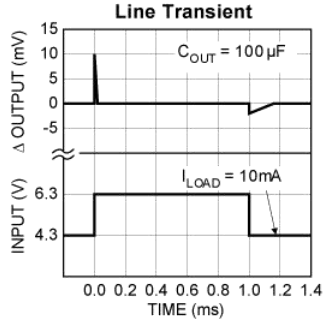
29302/3 Adjust Pin Current vs. Temperature



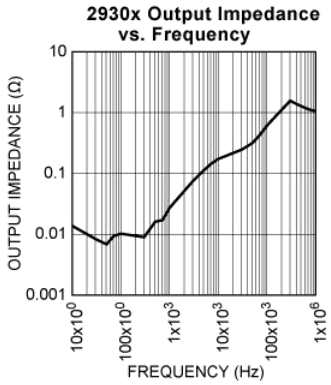
2930x Line Transient



2930x Line Transient

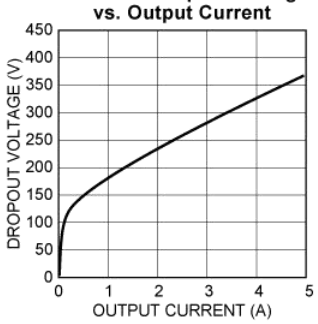


2930x Output Impedance vs. Frequency

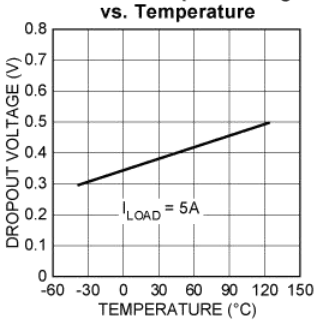


Typical Characteristics MIC2950x

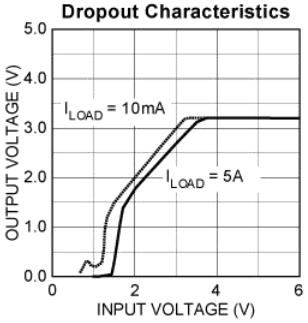
2950x Dropout Voltage vs. Output Current



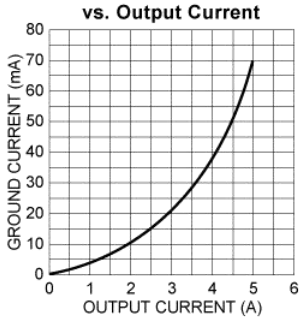
2950x Dropout Voltage vs. Temperature



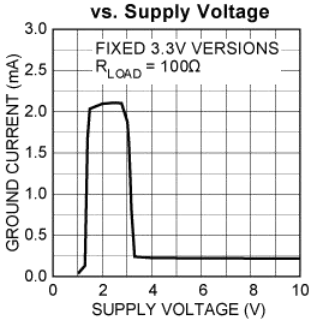
29500-3.3 Dropout Characteristics



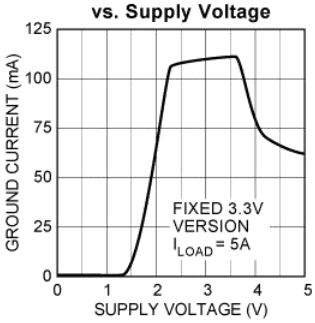
2950x Ground Current vs. Output Current



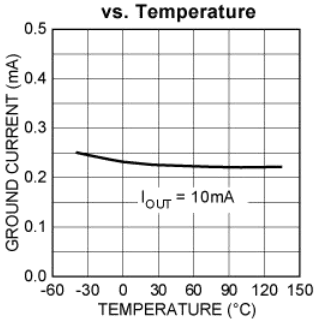
2950x Ground Current vs. Supply Voltage



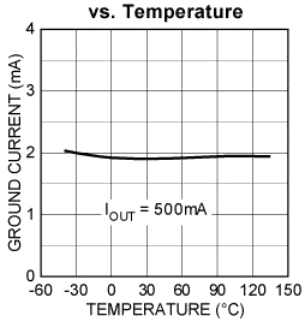
2950x Ground Current vs. Supply Voltage



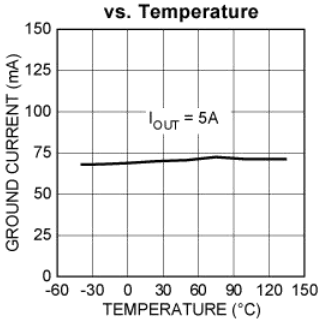
2950x Ground Current vs. Temperature



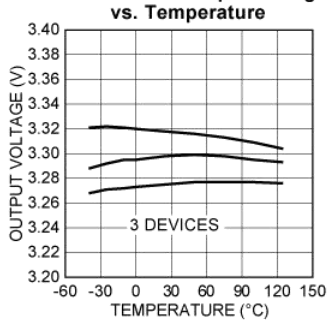
2950x Ground Current vs. Temperature



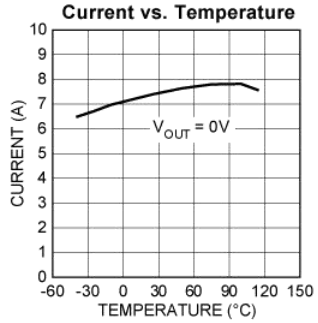
2950x Ground Current vs. Temperature



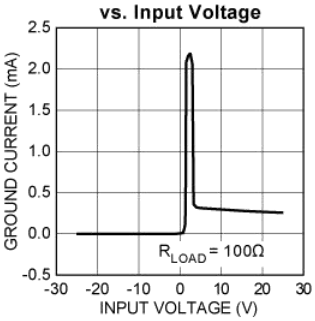
29500-3.3 Output Voltage vs. Temperature



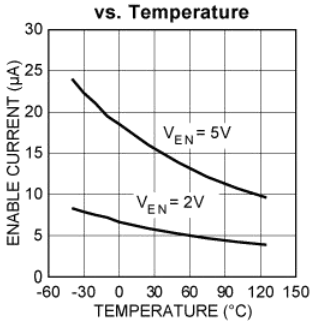
2950x-5.0 Short Circuit Current vs. Temperature



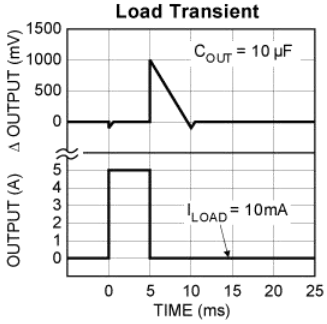
2950x Ground Current vs. Input Voltage



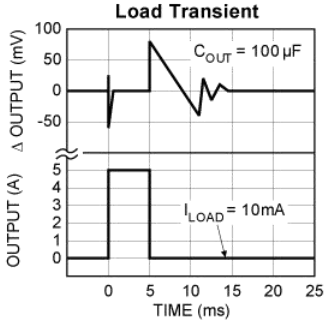
29501-xx/2 Enable Current vs. Temperature



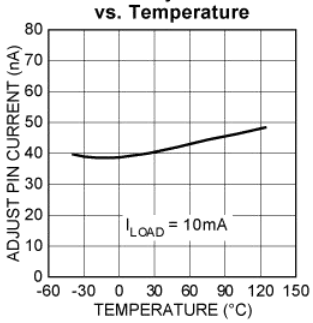
2950x Load Transient



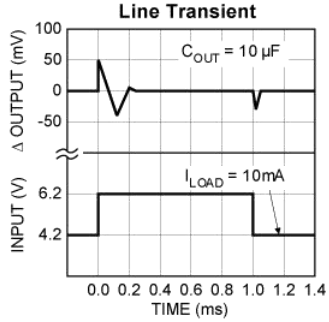
2950x Load Transient



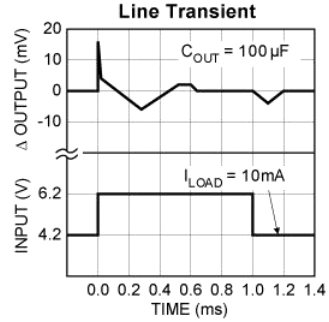
29502/3 Adjust Pin Current vs. Temperature



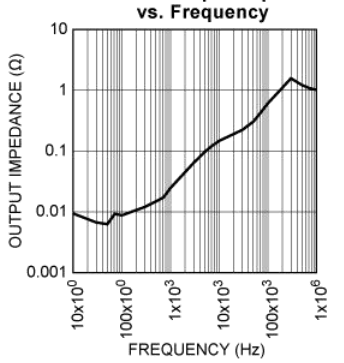
2950x Line Transient



2950x Line Transient

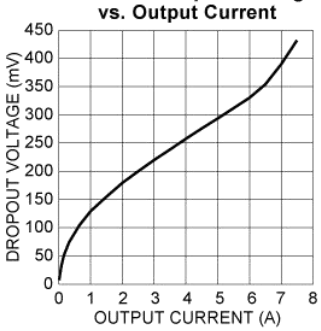


2950x Output Impedance vs. Frequency

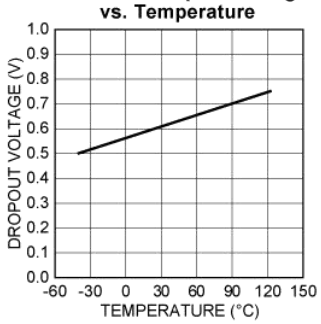


Typical Characteristics MIC2975x

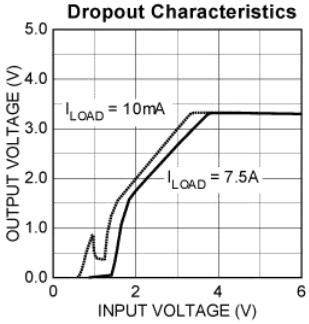
2975x Dropout Voltage vs. Output Current



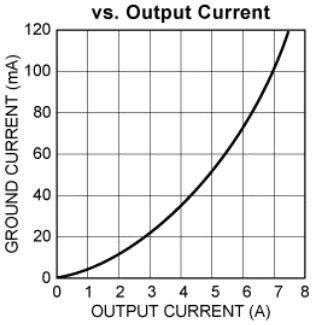
2975x Dropout Voltage vs. Temperature



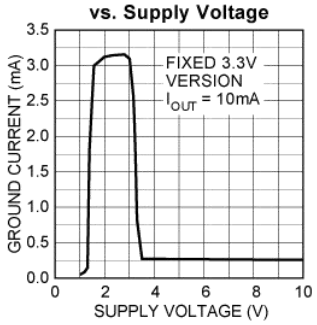
29750-3.3 Dropout Characteristics



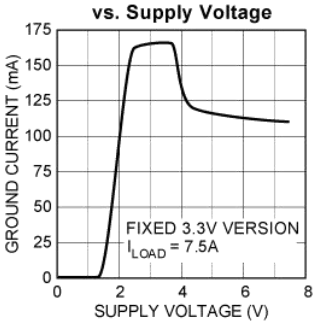
2975x Ground Current vs. Output Current



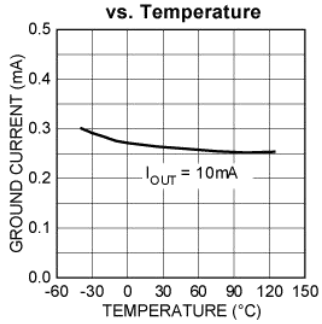
2975x Ground Current vs. Supply Voltage



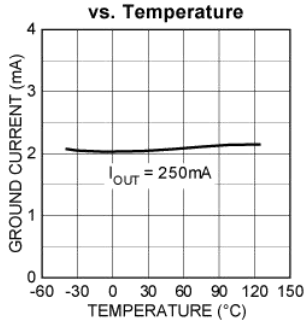
2975x Ground Current vs. Supply Voltage



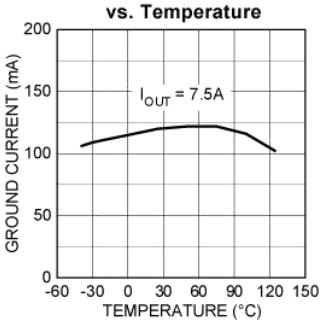
2975x Ground Current vs. Temperature



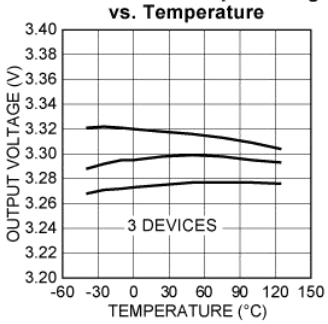
2975x Ground Current vs. Temperature



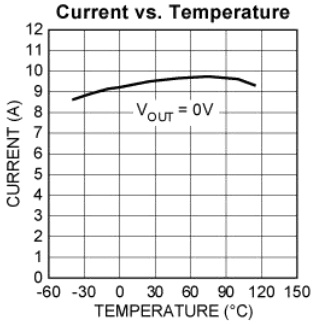
2975x Ground Current vs. Temperature



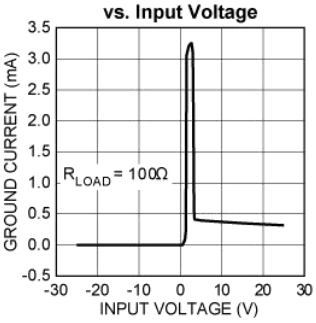
29750-3.3 Output Voltage vs. Temperature



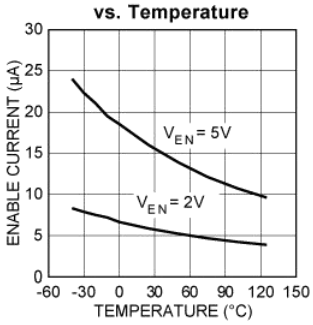
29750-5.0 Short Circuit Current vs. Temperature



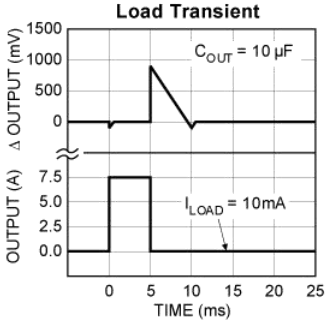
2975x Ground Current vs. Input Voltage



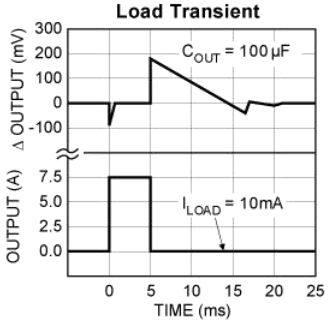
29751-xx/2 Enable Current vs. Temperature



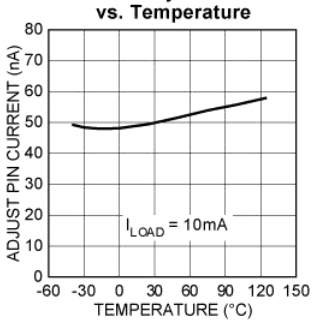
2975x Load Transient



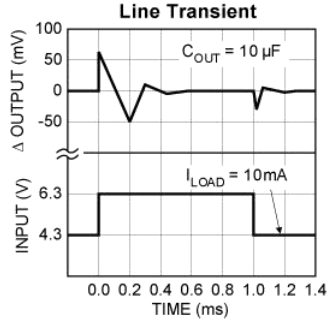
2975x Load Transient



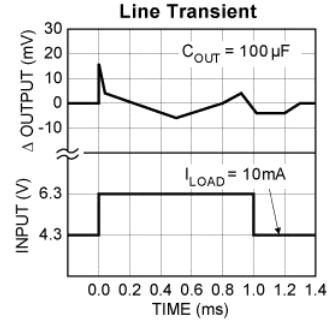
29752/3 Adjust Pin Current vs. Temperature



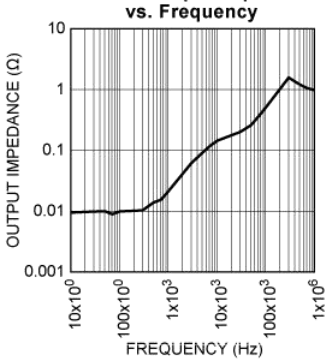
2975x Line Transient



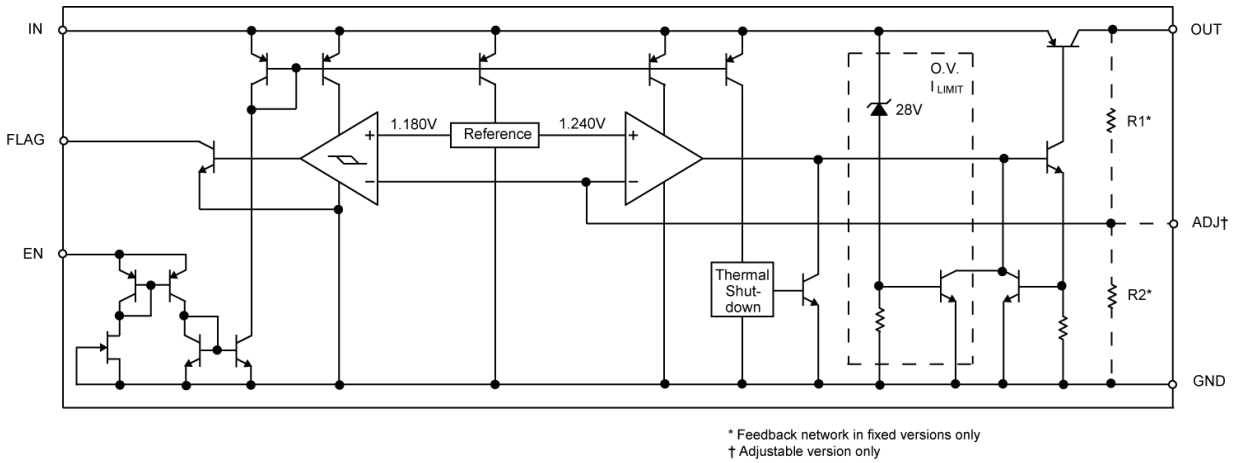
2975x Line Transient



2975x Output Impedance vs. Frequency



Functional Diagram



Application Information

The MIC29150/29300/29500/29750 are high performance low-dropout voltage regulators suitable for all moderate to high-current voltage regulator applications. Their 350mV to 425mV typical dropout voltage at full load make them especially valuable in battery powered systems and as high efficiency noise filters in “post-regulator” applications. Unlike older NPN- pass transistor designs, where the minimum dropout voltage is limited by the base-emitter voltage drop and collector-emitter saturation voltage, dropout performance of the PNP output of these devices is limited merely by the low VCE saturation voltage.

A trade-off for the low-dropout voltage is a varying base driver requirement. But Super ßeta PNP ® process reduces this drive requirement to merely 1% of the load current.

The MIC29150/29300/29500/29750 family of regulators are fully protected from damage due to fault conditions. Current limiting is provided. This limiting is linear; output current under overload conditions is constant. Thermal shutdown disables the device when the die temperature exceeds the 125°C maximum safe operating temperature. Transient protection allows device (and load) survival even when the input voltage spikes between +7V and +26V. When the input voltage exceeds about 20V to 26V, the over voltage sensor temporarily disables the regulator. The output structure of these regulators allows voltages in excess of the desired output voltage to be applied without reverse current flow.MIC29xx1 and MIC29xx2 versions offer a logic level ON/OFF control: when disabled, the devices draw nearly zero current.

An additional feature of this regulator family is a common pinout: a design’s current requirement may change up or down yet use the same board layout, as all of these regulators have identical pinouts.

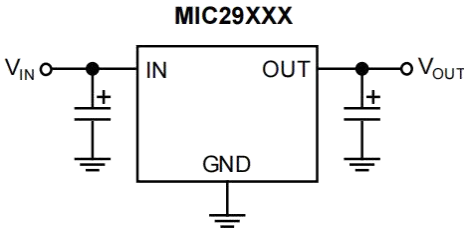


Figure 3. Linear regulators require only two capacitors for operation.

Thermal Design

Linear regulators are simple to use. The most complicated design parameters to consider are thermal characteristics. Thermal design requires the following application-specific parameters:

- Maximum ambient temperature, TA
- Output Current, IOUT
- Output Voltage, VOUT
- Input Voltage, VIN

First, we calculate the power dissipation of the regulator from these numbers and the device parameters from this datasheet.

$$P_D = I_{OUT}(1.01V_{IN} - V_{OUT})$$

Where the ground current is approximated by 1% of IOUT. Then the heat sink thermal resistance is determined with this formula:

$$\theta_{SA} = \frac{T_{JMAX} - T_A}{P_D} - (\theta_{JC} + \theta_{CS})$$

Where TJMAX ≤ 125°C and θCS is between 0 and 2°C/W.

The heat sink may be significantly reduced in applications where the minimum input voltage is known and is large compared with the dropout voltage. Use a series input resistor to drop excessive voltage and distribute the heat between this resistor and the regulator. The low-dropout properties of Super ßeta PNP® regulators allow very significant reductions in regulator power dissipation and the associated heat sink without compromising performance. When this technique is employed, a capacitor of at least 0.1µF is needed directly between the input and regulator ground.

Please refer to Application Note 9 and Application Hint 17 for further details and examples on thermal design and heat sink specification.

With no heat sink in the application, calculate the junction temperature to determine the maximum power dissipation that will be allowed before exceeding the maximum junction temperature of the 29152. The maximum power allowed can be calculated using the thermal resistance (θJA) of the D-Pak adhering to the following criteria for the PCB design: 2 oz. copper and 100mm2 copper area for the 29152.

For example, given an expected maximum ambient temperature (TA) of 75 C with VIN = 3.3V, VOUT = 2.5V, and IOUT = 1.5A, first calculate the expected PD using Equation (1);

PD=(3.3V–2.5V)1.5A-(3.3V)(0.016A)=1.1472W

Next, calcualte the junction temperature for the expected power dissipation.

$T_J=(\theta_{JA}\times P_D)+T_A=(56°C/W\times 1.1472W)+75°C=139.24°C$

Now determine the maximum power dissipation allowed that would not exceed the IC's maximum junction temperature (125℃) without the useof a heat sink by $P_{D(MAX)}=(T_{J(MAX)}–TA)/\theta JA=(125℃–75℃)/(56℃/W)$ =0.893W

Capacitor Requirements

For stability and minimum output noise, a capacitor on the regulator output is necessary. The value of this capacitor is dependent upon the output current; lower currents allow smaller capacitors.

This capacitor need not be an expensive low ESR type: aluminum electrolytics are adequate. In fact, extremely low ESR capacitors may contribute to instability. Tantalum capacitors are recommended for systems where fast load transient response is important.

Where the regulator is powered from a source with a high AC impedance, a 0.1µF capacitor connected between Input and GND is recommended. This capacitor should have good characteristics to above 250kHz.

Minimum Load Current

The MIC29150–29750 regulators are specified between finite loads. If the output current is too small, leakage currents dominate and the output voltage rises. The following minimum load current swamps any expected leakage current across the operating temperature range:

Device	Minimum Load
29150	5mA
29300	7mA
29500	10mA
29750	10mA

Adjustable Regulator Design

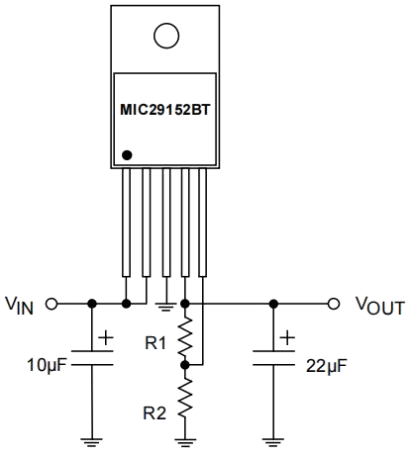


Figure 4. Adjustable Regulator with Resistors

The adjustable regulator versions, MIC29xx2 and MIC29xx3, allow programming the output voltage anywhere between 1.25V and the 25V. Two resistors are used. The resistor values are calculated by:

$$R_1 = R_2 \times \left(\frac{V_{OUT}}{1.240} - 1\right)$$

where VOUT is the desired output voltage. Figure 4 shows component definition. Applications with widely varying load currents may scale the resistors to draw the minimum load current required for proper operation (see “Minimum Load Current” section).

Error Flag

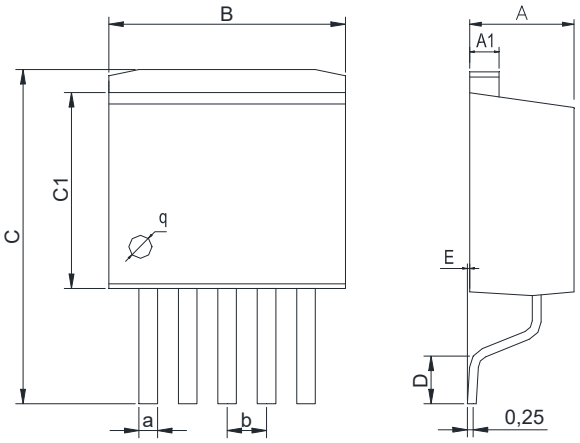
MIC29xx1 and MIC29xx3 versions feature an Error Flag, which looks at the output voltage and signals an error condition when this voltage drops 5% below its expected value. The error flag is an open-collector output that pulls low under fault conditions. It may sink 10mA. Low output voltage signifies a number of possible problems, including an overcurrent fault (the device is in current limit) and low input voltage. The flag output is inoperative during overtemperature shutdown conditions.

Enable Input

MIC29xx1 and MIC29xx2 versions feature an enable (EN) input that allows ON/OFF control of the device. Special design allows “zero” current drain when the device is disabled—only microamperes of leakage current flows. The EN input has TTL/CMOS compatible thresholds for simple interfacing with logic, or may be directly tied to ≤26V. Enabling the regulator requires approximately 20µA of current.

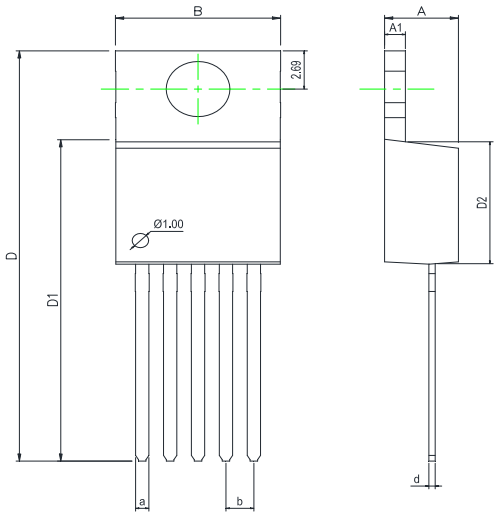
Physical Dimensions

TO-263-5



Dimensions In Millimeters(TO-263-5)									
Symbol:	A	A1	B	C	C1	D	E	a	b
Min:	4.45	1.22	10	13.7	8.40	1.90	0	0.71	1.70BSC
Max:	4.62	1.32	10.4	14.6	8.90	2.10	0.20	0.97	

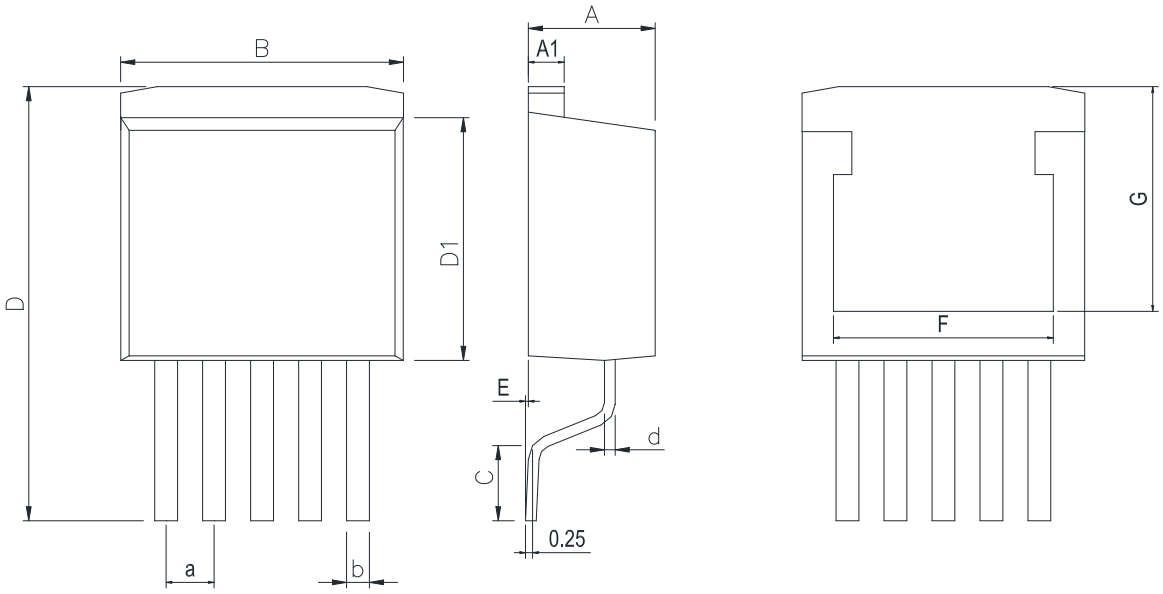
TO-220-5



Dimensions In Millimeters(TO-220-5)									
Symbol:	A	A1	B	D	D1	D2	a	d	b
Min:	4.52	1.25	10	28.2	22.4	8.69	0.71	0.33	1.70BSC
Max:	4.62	1.29	10.3	28.9	22.6	8.79	0.97	0.42	

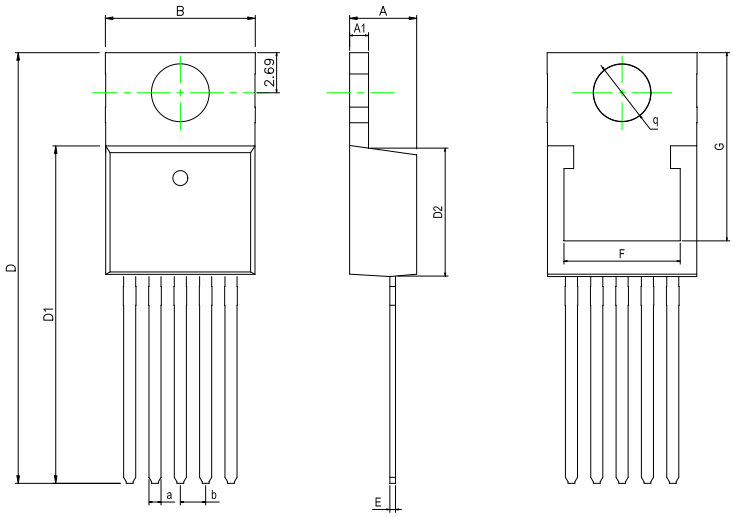
Physical Dimensions

TO-263-5-A2



Dimensions In Millimeters(TO-263-5-A2)											
Symbol:	A	A1	B	C	D	D1	E	a	b	F	G
Min:	4.40	1.25	9.80	2.10	14.7	8.50	0	0.71	0.71	7.80TYP	7.97TYP
Max:	4.60	1.30	10.4	2.60	15.6	9.10	0.30	0.91	0.91		

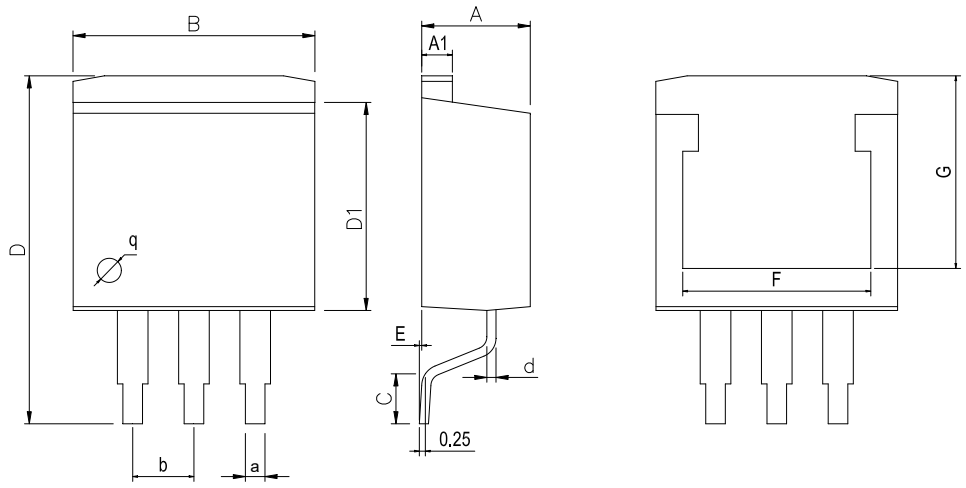
TO-220-5 (A2)



Dimensions In Millimeters(TO-220-5)												
Symbol:	A	A1	B	D	D1	D2	E	F	G	a	b	q
Min:	4.40	1.22	9.8	28.5	22.4	8.50	0.33	7.70	12.55	0.71	1.70	3.80
Max:	4.60	1.32	10.4	28.9	22.7	9.10	0.43	7.90	12.65	0.97	BSC	TYP

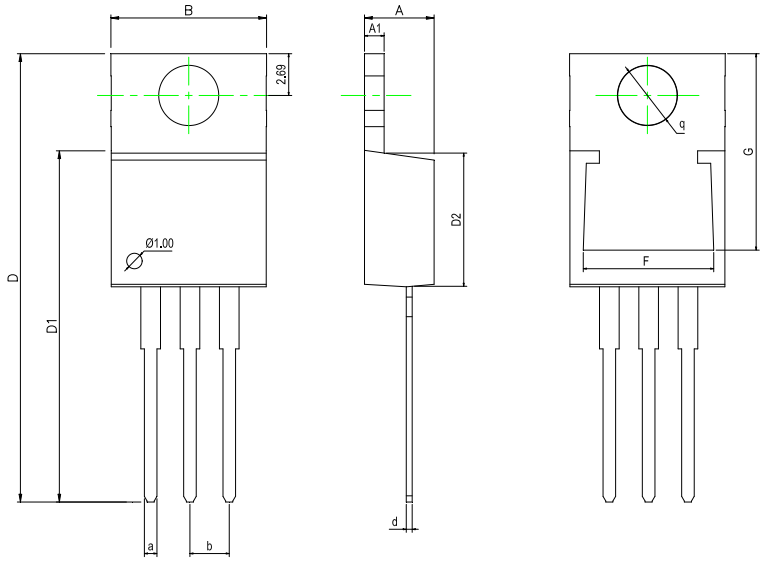
Physical Dimensions

TO-263-3



Dimensions In Millimeters(TO-263-3)											
Symbol:	**A**	**A1**	**B**	**C**	**D**	**D1**	**E**	**F**	**G**	**a**	**b**
Min:	4.45	1.22	10	1.89	14.1	8.38	0	7.20	7.20	0.71	2.54BSC
Max:	4.62	1.32	10.4	2.19	15.3	8.89	0.305	8.10	8.10	0.97	

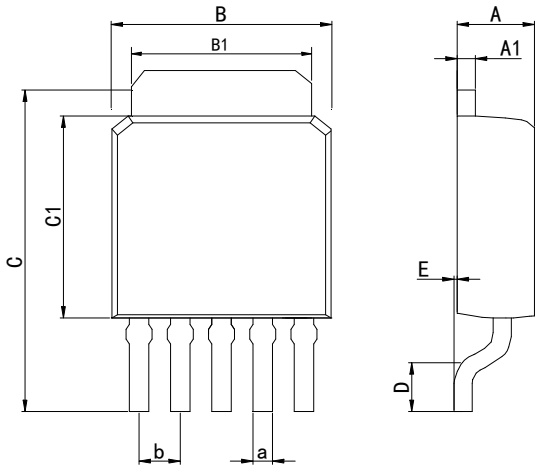
TO-220-3



Dimensions In Millimeters(TO-220-3)												
Symbol:	A	A1	B	D	D1	D2	F	G	a	d	b	q
Min:	4.45	1.22	10	28.2	22.22	8.50	8.30	12.55	0.71	0.33	2.54	3.80
Max:	4.62	1.32	10.4	28.9	22.62	9.10	8.55	12.75	0.97	0.42	BSC	TYP

Physical Dimensions

TO-252-5



Dimensions In Millimeters(TO-252-5)										
Symbol:	A	A1	B	B1	C	C1	D	E	a	b
Min:	2.10	0.45	6.40	5.10	9.20	5.30	0.90	0	0.50	1.27
Max:	2.50	0.70	6.80	5.50	10.6	6.30	1.75	0.23	0.80	BSC

Revision History

REVISION NUMBER	DATE	REVISION	PAGE
V1.0	2018-8	New	1-24
V1.1	2021-7	Update encapsulation type、Update Pin Configuration	1、3
V1.2	2024-11	Update Lead Temperature	4
V1.3	2025-10	Update TO-263-3 Physical Dimensions、Update important statements	20、23

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